

(12) UK Patent Application (19) GB (11) 2 120 457 A

(21) Application No 8311490
 (22) Date of filing 27 Apr 1983
 (30) Priority data
 (31) 57/069508
 (32) 27 Apr 1982
 (33) Japan (JP)
 (43) Application published
 30 Nov 1983
 (51) INT CL³
 H01L 31/12 27/04 H01S
 3/02 3/096
 (52) Domestic classification
 H1K 1EA 1EB 9D1 9D2
 9P3 9R2 ED
 H1C 215 231 233 249
 352 35Y 363 569 CA
 (56) Documents cited
 GB 1594656
 GB 1517537
 GB 1155590
 (58) Field of search
 H1K
 H1C

(71) Applicant
 Kokusai Denshin Kenwa
 Kabushiki Kaisha
 (Japan),
 2-3-2 Nishishinjuku,
 Shinjuku-ku, Tokyo-to,
 Japan
 (72) Inventors
 Shigeyuki Akiba,
 Katsuyuki Utaka,
 Kazuo Sakai,
 Yuichi Matsushima
 (74) Agent and/or Address for
 Service
 Elkington and Fife,
 High Holborn House,
 52/54 High Holborn,
 London WC1V 6SH

(54) Distributed feedback semiconductor laser integrated with monitor

(57) A distributed feedback semiconductor laser integrated with a monitor has periodic corrugations 7 on a light emitting layer 3 or an adjoining layer 2 in the direction of travel of light and performs laser oscillation by the injection of a current into said light emitting layer. A gap between said monitor region and said laser region is filled with a semiconductor (12) of an energy bandgap larger than that of the light emitting layer (3) of said laser region so that light directed to the monitor region is not absorbed. The region 12 may be multi-layered.

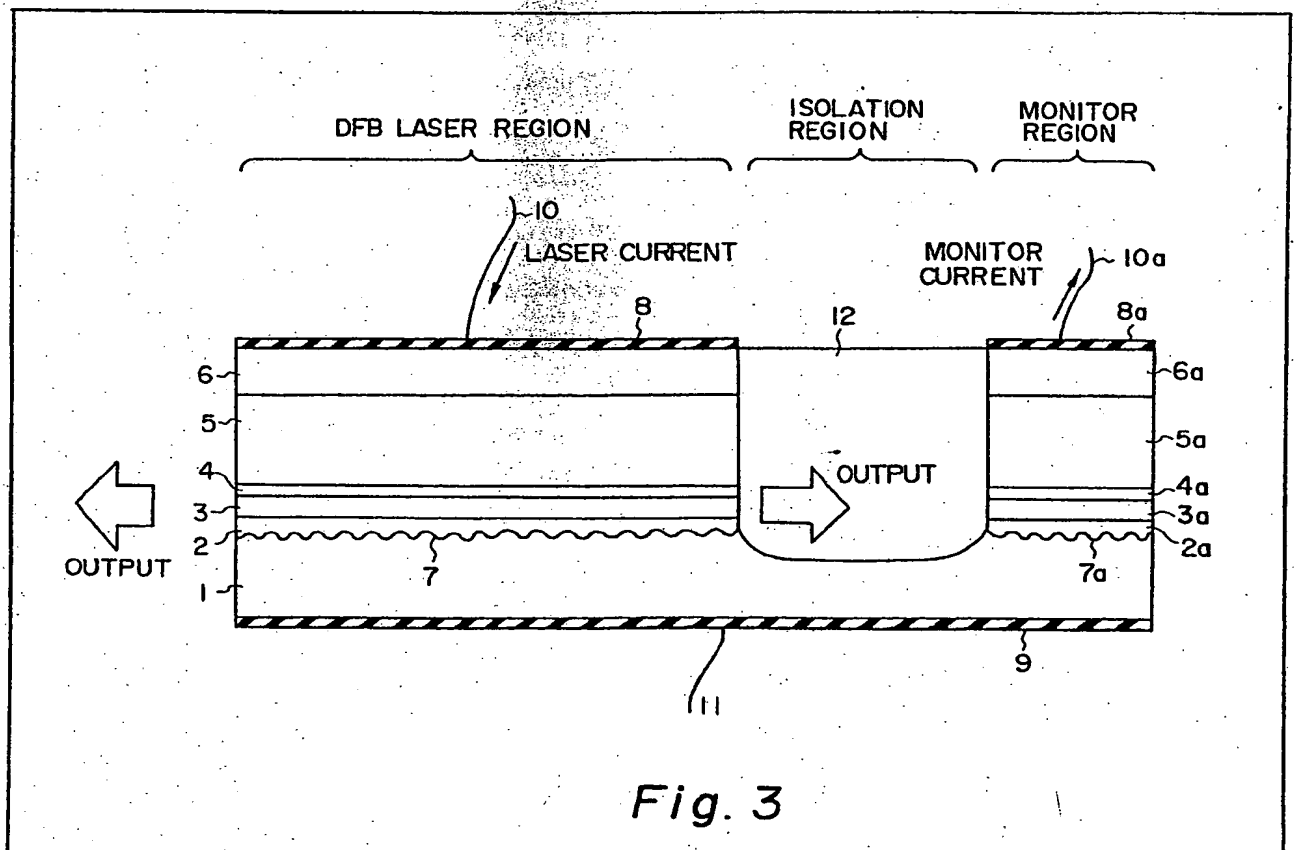


Fig. 3

Fig. 1

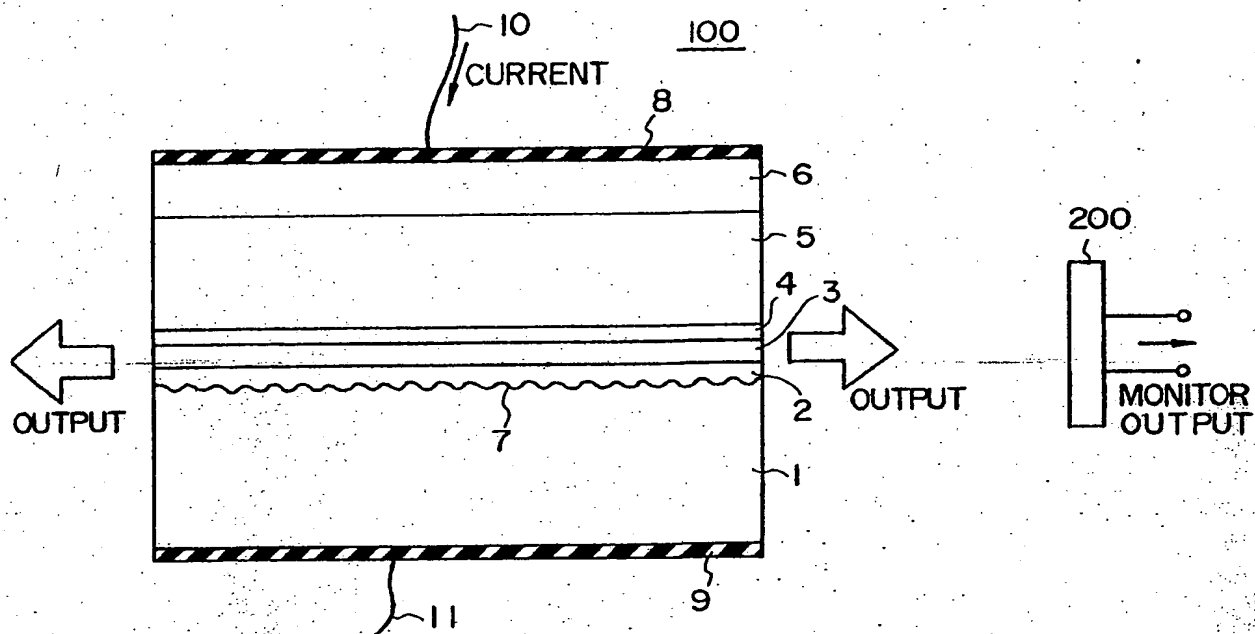


Fig. 2

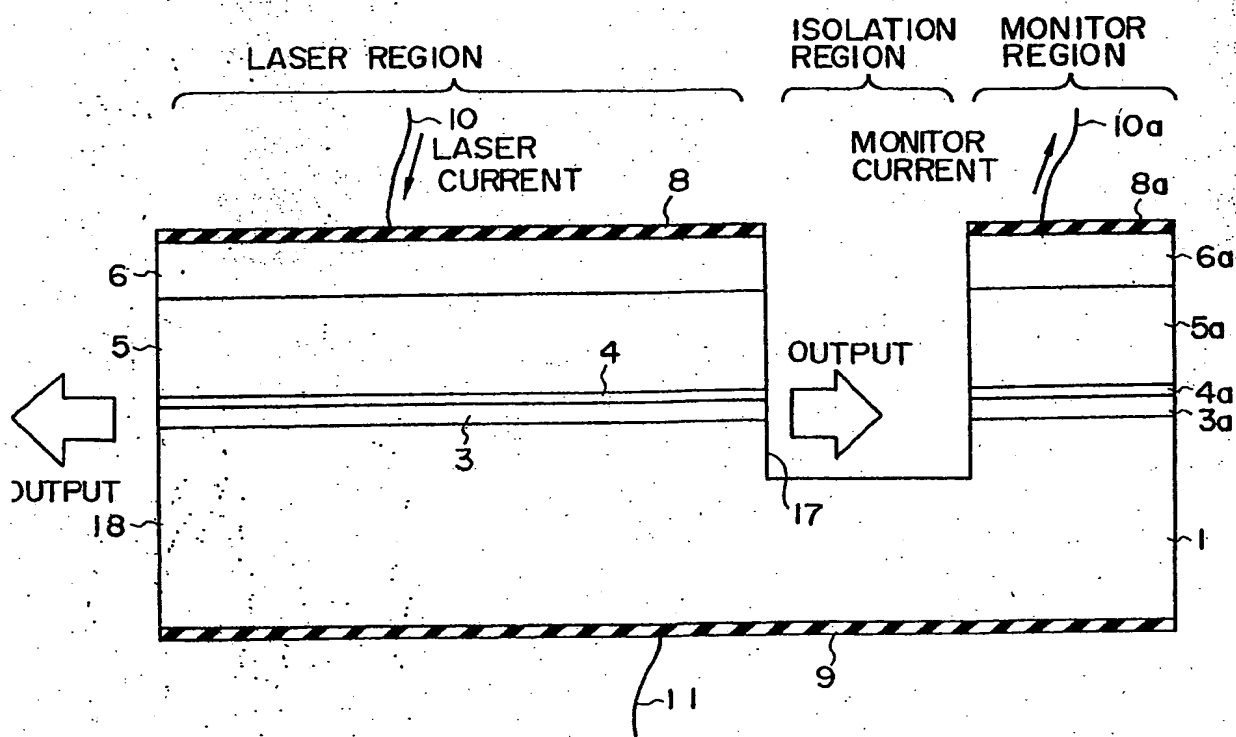


Fig. 3

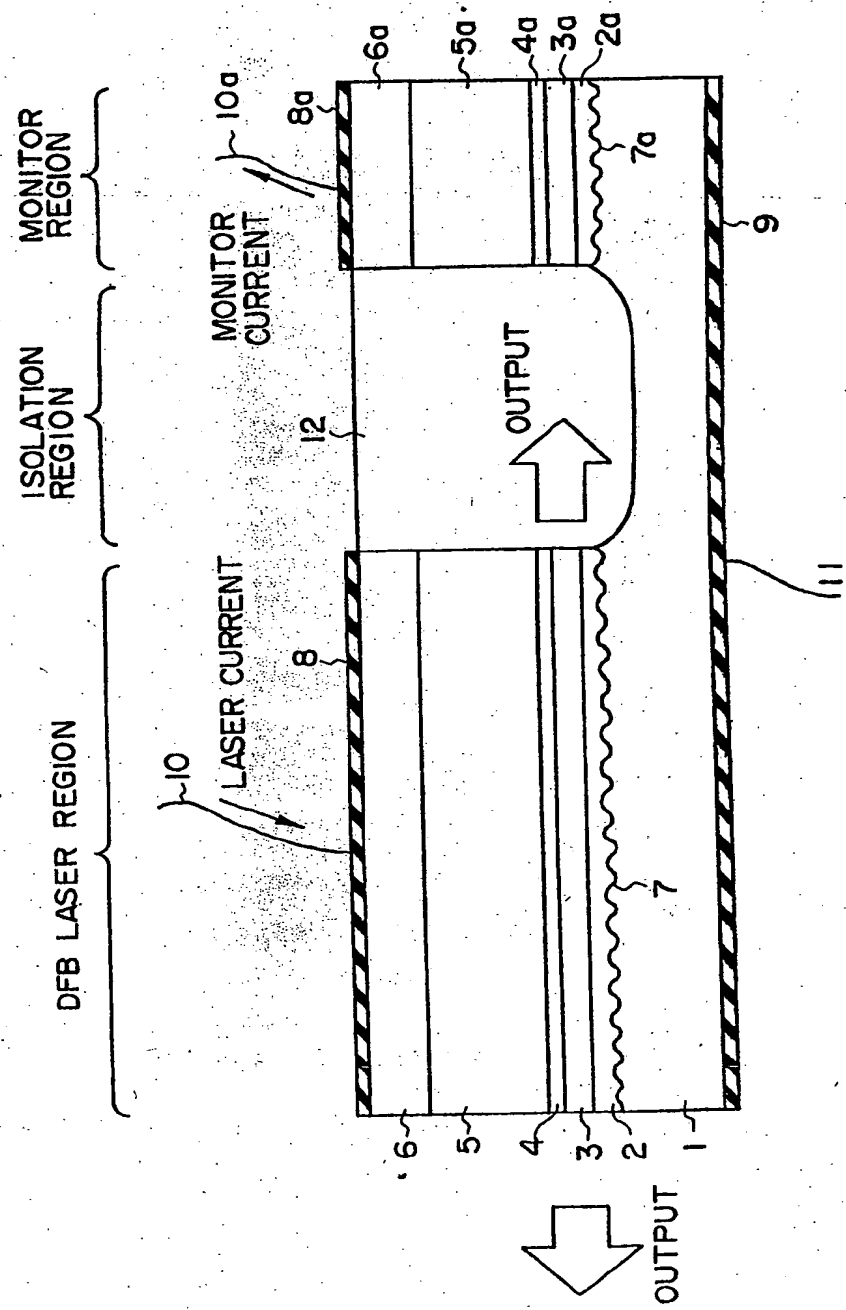


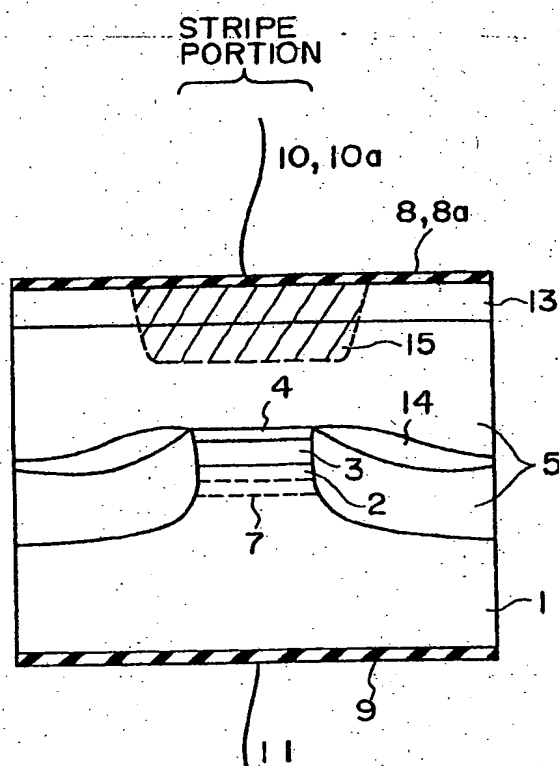
Fig. 4A

Fig. 4B

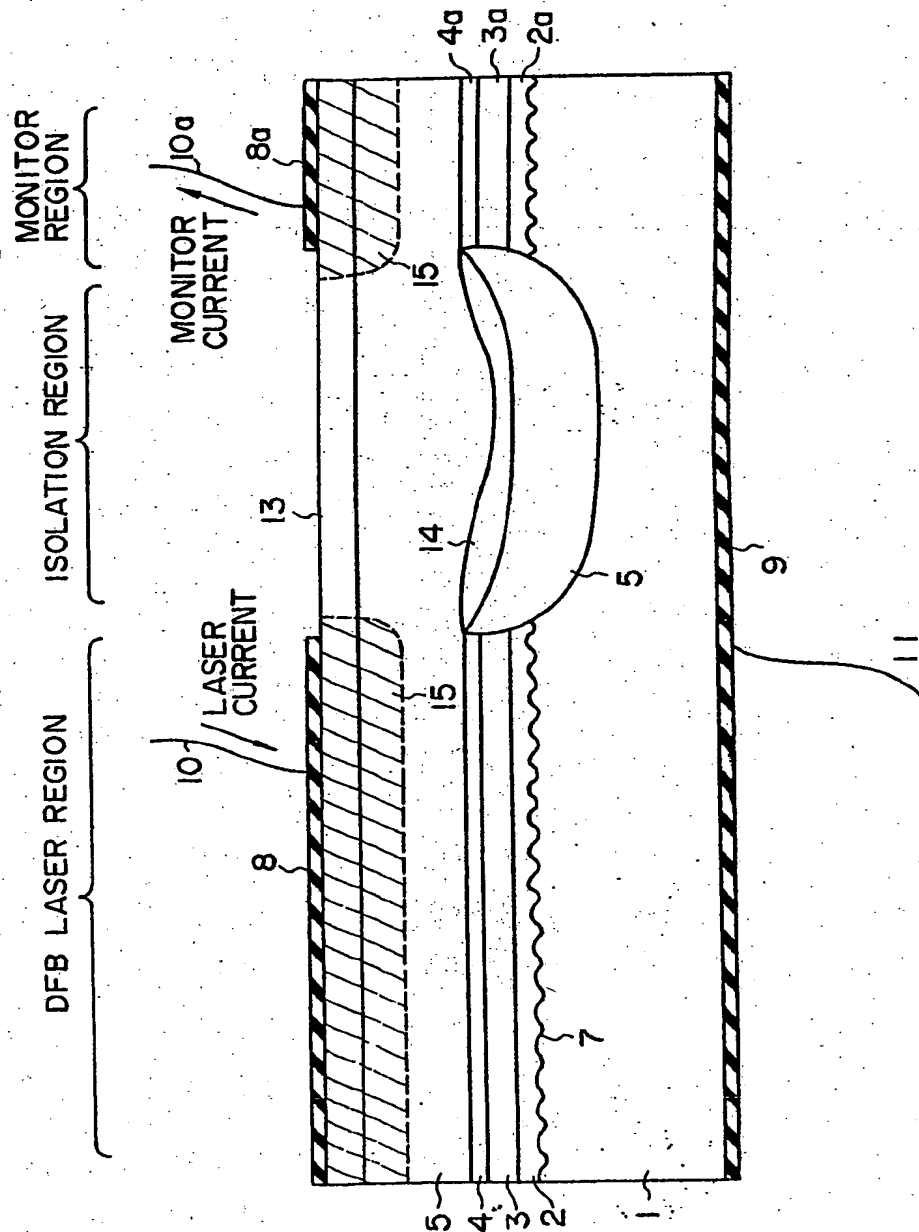
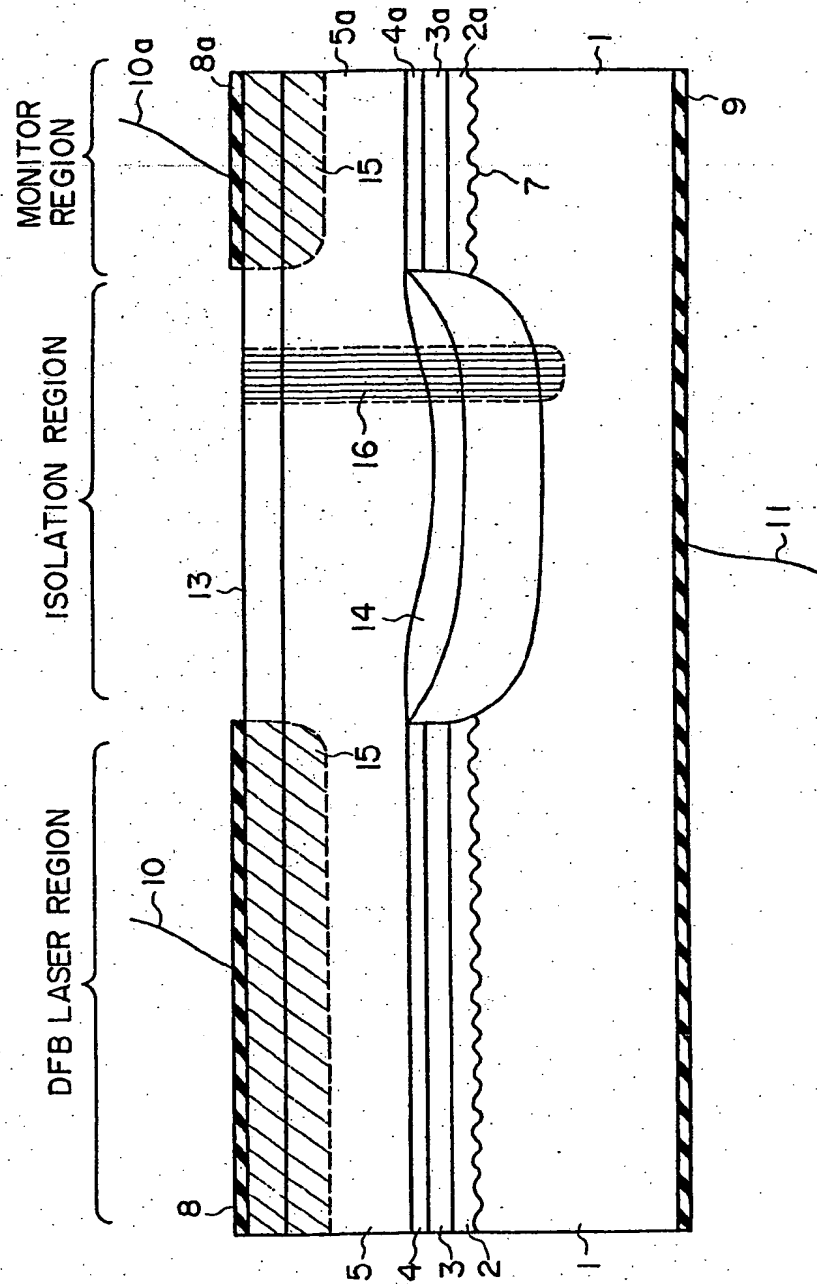


Fig. 5



SPECIFICATION

Distributed feedback semiconductor laser with monitor

The present invention relates to integration of a semiconductor laser and a photo-detector for monitoring the output light thereof.

A distributed feedback laser (hereinafter referred to as a DFB laser) is an excellent laser which performs single longitudinal mode oscillation, and it is expected as a light source for high quality optical fiber communications. When monitoring the output light of a conventional semiconductor laser, a monitor is provided at the outside or in combination with the distributed feedback laser. However, it is very difficult to associate a monitor with a distributed feedback laser so as effectively and stably to detect the output light of the distributed feedback laser.

In view of such defects of the prior art, an object of the present invention is to provide a distributed feedback semiconductor laser with a monitor in which the DFB laser and an output light monitoring photo-detector are disposed on the same substrate so as to make the most of the features of the DFB laser and to obviate the inconveniences arising from separate assembling of the laser and the photo-detector.

In accordance with the present invention, there is provided a distributed feedback semiconductor laser with a monitor, which has periodic corrugations on a light emitting layer or an adjoining layer in the direction of travel of light and performs laser oscillation by the injection of current into said light emitting layer, characterised in that a laser region forming said distributed feedback semiconductor laser and a monitor region for detecting the output of said laser region are disposed on the same substrate, and in that a gap between said monitor region and said laser region is filled with a semiconductor of an energy band-gap larger than that of the light emitting layer of said laser region.

Embodiments of the present invention will now be described, by way of example, by comparison with known arts and with reference to the accompanying drawings, in which:

Fig. 1 is a sectional view showing a prior art example of the arrangement of a DFB laser and a photo-detector for monitoring it;

Fig. 2 is a sectional view showing a prior art example in which a Fabry-Perot type laser and a monitor are disposed on the same substrate;

Fig. 3 is a sectional view illustrating an embodiment of the present invention; and

Figs. 4A, 4B and 5 are sectional views illustrating other embodiments of the present invention as applied to a buried stripe structure.

For ready understanding the features and merits of the present invention, prior arts will first be described.

Fig. 1 illustrates an example of the DFB laser formed of a semiconductor of InGaAsP/InP alloys. In Fig. 1, reference numeral 1 indicates an n-type InP substrate; 2 designates an n-type InGaAsP

waveguide layer; 3 identifies an InGaAsP light emitting layer; 4 denotes an InGaAsP buffer layer for preventing a meltback of the light emitting layer 3; 5 represents a p-type InP layer; 6 shows a p-type InGaAsP cap layer; 8 and 9 refer to electrodes; and 10 and 11 signify leads. Periodic corrugations 7 are characteristic of the DFB laser, and its oscillation frequency is determined directly by the period of the corrugations. With the DFB laser, since the periodic structure itself serves as a resonator, there is no need for a cleavage plane for forming a Fabry-Perot resonator necessary for a conventional semiconductor laser, and it is rather preferable that light is not reflected at the output end.

On the other hand, in the case of monitoring the output light of the conventional semiconductor laser, it is general practice in the prior art to employ such an arrangement as shown in Fig. 1 in which, for example, a germanium photodiode or the like is disposed as a photo-detector 200 on an extension of the one output end for monitoring the output current. With such a monitoring system, it is necessary to fabricate a laser 100 and the photo-detector 200 separately from each other and to stabilize their relative positions. Furthermore, in the case of arranging a plurality of lasers, the overall apparatus becomes bulky and its assembly is also difficult.

Such a prior art example as shown in Fig. 2 in which a Fabry-Perot type laser and an output light monitor are integrated together, provides a solution to the above said problem. An end face 18 is formed by ordinary cleavage and the other end face 17 is formed by chemical etching or the like. However, it is difficult to form the end face 17 in parallel to the end face 18. Moreover, when the end face 17 is also formed by cleavage, a special layer structure must be employed.

The present invention will hereinafter be described in more detail below. Fig. 3 illustrates an embodiment of the present invention. After forming a wafer of the same layer structure as the DFB laser of Fig. 1, an isolation region defined between the laser region and the monitor region, for isolating them, is homogeneously filled with a semiconductor 12 of a larger energy bandgap than that of the light emitting layer 3, for example, of high resistance InP, and electrodes 8 and 8a and leads 10 and 10a are provided for the laser and the monitor region independently of each other, forming the DFB laser region and the monitor region on the same substrate 1. With such a structure, the buried portion of the semiconductor 12 has a larger energy bandgap than does the light emitting region 3, and hence does not absorb the output light from the laser region and is a transparent window; this permits the output light readily to reach the monitor region and appreciably reduces reflection at the boundary between the light emitting layer 3 and the buried portion 12, ensuring the provision of stabilized laser oscillation. On the other hand, in this embodiment, a light detecting portion 3a of the monitor region is identical in layer structure with

the light emitting layer 3 of the DFB laser region but sufficiently able to detect light since the photon energy of the output light is usually slightly larger than the energy bandgap of the light emitting layer 3 of the DFB laser region. Of course, the layer structure of the monitor region need not always be the same as the layer structure of the DFB laser region but the light detection is possible if the energy gap of the light detecting layer is equal to or smaller than the energy bandgap of the light emitting layer. However, it is evidently advantageous, in terms of ease of manufacture, to employ the same layer structure for the DFB laser region and the monitor region.

While no mention has been made in the foregoing of a buried stripe structure for stabilizing the lateral mode of the laser, an embodiment of the DFB laser is shown in Fig. 4A and 4B, which employs the buried stripe structure for lateral mode stabilization. Fig. 4A shows the layer structure as viewed from the plane from which light is emitted, and Fig. 4B the layer structure as viewed from the lateral direction. The p-type InP layer 5 and n-type InP layer 14 are buried in the portion outside the isolation region and the stripe portion, by which a window effect for the output light of the lateral mode stabilized DFB laser and a current blocking function are provided in combination. A cap layer 13 is an n-type InGaAsP layer in this case, and a Zn-diffused region 15 (indicated by hatching) is formed only in a current path portion. On the other hand, from the viewpoint of electrical isolation of the DFB laser region and the monitor region, the p-type InP layer 5 is formed to extend into both of them in the structure of Fig. 4A and 4B, so that they are not completely isolated. Consequently, a portion of a voltage applied to the DFB laser region leaks out into the monitor region, resulting in a monitor current becoming a superimposition of a current generated by light detection on the leakage current. This evil can be removed by additionally providing an external circuit for eliminating the leakage current in evidence, but the leakage current can be blocked by providing an electrical isolation region 16 (indicated by vertical lines) in the isolation region in the vicinity of the monitor region as shown in Fig. 5. This can be achieved, for instance, by introducing an impurity into the region 16 by diffusion or ion implantation to form an n-type InP region, by applying protons or the

like to the region 16 to form a high resistance region, or by removing the region 16 through etching from the device.

As has been described in the foregoing, according to the present invention, the laser and the monitor are integrated on the same substrate and, by employing the same layer structure for the laser and the monitor portion, the DFB laser with a monitor can easily be manufactured without increasing the number of steps involved in its manufacture. Moreover, since reflection at one end face of the DFB laser is small, the characteristics of the DFB laser itself are improved, fully exhibiting the features of the single longitudinal mode laser.

Furthermore, although the foregoing description has been given of the case of using the semiconductors of InGaAsP alloys, the present invention can also easily be applied to other materials of AlGaAs alloys and so on. The present invention is also applicable not only to the buried stripe structure but also to other stripe structures.

Such DFB laser with a monitor is very promising as a light source for high performance optical fiber communications, and hence is of great utility.

CLAIMS

1. A distributed feedback semiconductor laser with a monitor, which has periodic corrugations on a light emitting layer or an adjoining layer in the direction of travel of light and performs laser oscillation by the injection of current into said light emitting layer, wherein a laser region forming said distributed feedback semiconductor laser and a monitor region for detecting the output of said laser region are disposed on the same substrate, and a gap between said monitor region and said laser region is filled with a semiconductor of an energy band-gap larger than that of the light emitting layer of said laser region.

2. A distributed feedback semiconductor laser with a monitor according to claim 1, in which the semiconductor is an InP of high resistance.

3. A distributed feedback semiconductor laser with a monitor according to claim 2, in which InP is of n-type.

4. A distributed feedback semiconductor substantially as herein described with reference to Figures 3, 4A and 4B or 5 of the accompanying drawings.